

Alcatel 1945 LMM

10 Gb/s EA-ILM laser module

With integrated wavelength monitoring

Description

The Alcatel 1945 LMM contains a state-of-the-art high performance DFB laser chip integrated with an electro-absorption modulator (EA-ILM) and is designed for 10Gb/s long haul DWDM digital transmission systems on (up to 90km distance on SMF). This module is designed for DWDM applications with a spacing between the channels down to 50 GHz without using external locker. The module integrates a wavelength monitoring function in order to allow wavelength stabilization over product lifetime. Despite of this new feature, the package and the pinout of the new product stays compatible with the previous series , Alcatel 1915 LMM, without the integrated wavelength monitoring function, in order to avoid a complete redesign of existing boards. The choice of an analog output for the control signal will leave the freedom for the user to lock the wavelength either with a digital or an analog circuit. The module incorporates also a thermoelectric cooler, precision thermistor, and optical isolator for stable operation under all conditions.

Features

- Integrated Fabry-Perot Etalon wavelength monitoring (replaces external lockers)
- 50 GHz spacing ITU-T channels
- InGaAsP monolithically Integrated DFB Laser and Modulator chip (EA-ILM)
- Low drive voltage ($\leq 2V_{pp}$)
- Very low power penalty over 90 Km of standard fiber for 10Gb/s operation
- Internal optical isolator
- Internal TEC and power monitoring photodiode
- High frequency industry-standard 7-pin butterfly package with 50Ω RF input and either K or GPO RF connector.

Applications

- STM-64 and OC-192 Long Reach DWDM transmission system
- Terminals for submarine DWDM transmission systems



Electro-Optic Characteristics

Parameter	Symb.	Conditions	Min	Max	Units
Laser					
Threshold current (BOL)	I_{TH}	CW, $V_{Bias} = 0V$	5	35	mA
Operating current (BOL)	I_{OP}	CW, $V_{Bias} = 0V$	60	80	mA
Laser forward voltage	V_F	CW, I_{OP} , $V_{Bias} = 0V$		2	V
Optical output power	P_{AVE}	I_{OP} , V_{mod} , (1)	-5		dBm
Laser chip temperature range for Wavelength tunability	$T\lambda$	See (3)	15	30	°C
Side mode suppression ratio	SMSR		35		dB
Dispersion penalty	DS	See (1), (2)		2	dB
Dynamic extinction ratio	DER	See note 1	10		dB
Modulator bias voltage	V_{Bias}	See (1)	-2	0	V
Modulator drive voltage	V_{MOD}	See (1)		2	V
Cut-off frequency	S_{21}	@-3 dB, $V_{Bias} = -1V$, 50Ω	10		GHz
RF return loss	S_{11}	$V_{Bias} = -1V$, DC to 7GHz	10		dB
Rise time / Fall time	t_r/t_f	(1), (2), 10%,90%		45	ps
Thermistor resistance	R_{TH}	$T_S = 25^\circ C$	9.5	10.5	k Ω
TEC current (EOL)	I_t	$I_{OP}=100mA$, $\Delta T=45^\circ C$, $T_C=65^\circ C$, $V_{Bias} = -1V$		1.3	A
TEC voltage (EOL)	V_t	$I_{OP}=100mA$, $\Delta T=45^\circ C$, $T_C=65^\circ C$, $V_{Bias} = -1V$		2.5	V
Tracking error	TR	$T_S=25^\circ C$, $T_C=65^\circ C$, $I_{OP}=100mA$, $TR=10\log[P(65^\circ C)/P(25^\circ C)]$	-0.5	+0.5	dB

Notes: All limits start of life, Tcase=25°C, Tsubmount=15 to 30°C, Vr=-5V, unless otherwise stated.

(1) BER = 10^{-10} ; 9.953 Gbit/s modulation; $2^{23} - 1$ PRBS; NRZ line code; DER≥10 dB, P_{AVE}

(2) 1600 ps/nm dispersion assuming fiber with an average dispersion of 18 ps/nm/km

Optical power in the fiber shall not exceed the linear transmission regime.

(3) Tchip = $T\lambda$. $T\lambda$ is chip temperature required to meet target wavelength

Wavelength monitoring section

Two photodiodes are used to ensure both optical power monitoring and wavelength monitoring. The first one (power monitoring) is referenced as monitoring photodiode (PD_{mon}) whereas the second one (wavelength monitoring) is referenced as filter photodiode (PD_{fill}).

	Symb.	Min	Max	Unit
Power Monitoring Photodiode current	I_{PDmon}	20		μA
Filter Monitoring Photodiode	I_{PDfill}	20		μA
Photodiodes dark current	I_{dark}		0.1	μA
Center wavelength	λ_c		ITU grid	
Wavelength stability over lifetime	$\Delta\lambda_c$	-2.5	+2.5	GHZ
Wavelength capture range	CR	90		GHZ
Filter slope (normalized to maximum PD _{fill} current)	FS	2	10	nm ⁻¹
Electrical responsivity ratio between power monitoring channel and filter monitoring channel	ERT		± 6	dB

Pin allocation

Pin	Description
1	λ Monitoring PD anode (-)
2	Thermistor
3	Laser DC Bias (+)
4	Power Monitoring PD Anode (-)
5	Common Power Monitoring and λ Monitoring PD Cathode (+)
6	TE Cooler (+)
7	TE Cooler (-)
8	EA modulator cathode
Case ground	Modulator anode/thermistor

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Standards

ITU-T G.652 optical fiber
IEC 68-2 and MIL STD 883 environment



LASER RADIATION
AVOID EXPOSURE TO BEAM
Class 3 B laser product



EUROPE

Route de Villejust
F-91625 NOZAY CEDEX
Tel : (+33) 1 64 49 49 10
Fax : (+33) 1 64 49 49 61

USA

15036 Conference Center Drive
CHANTILLY - VA 20151
Tel : (+1) 703 679 3600
Fax : (+1) 703 679 6667

CANADA

45, De Villebois, suite 200
Gatineau (PQ)
Canada, J8T 8J7
Tel : (+1) 819 243 3755
Fax : (+1) 819 243 3354

JAPAN

Yebisu Garden Place Tower
PO Box 5024
20-3, Ebisu 4 - Chome
Shibuya - ku TOKYO 150 - 6028
Tel : (+81) 3 5424 85 65
Fax : (+81) 3 5424 85 81

